

MN4049B/MN4049BS

Hex Inverting Buffer

■ Outline

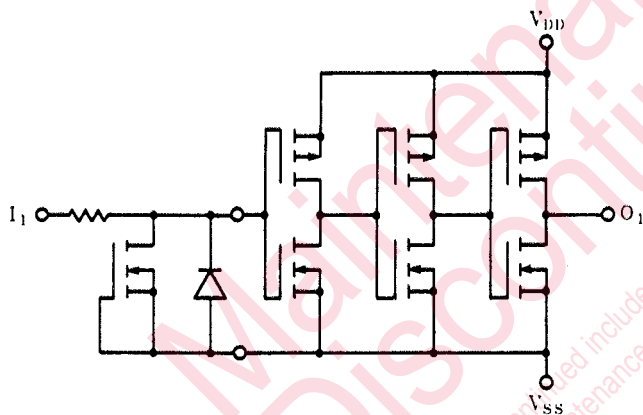
The MN4049B/S is an inversion type buffer having six circuits, and usable for logical level conversion.

Because of the large output current, it can directly drive TTL and DTL, and is also usable as an interface from CMOS to TTL since it can drive two standard TTL circuits.

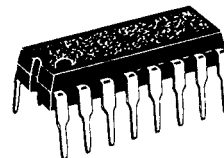
The circuits structurally constituting a 3-stage inverter assure excellent switching characteristics.

This hex inverting buffer is equivalent to Motorola's MC14049BB and RCA's CD4049B.

■ Schematic Diagram (1/6) & Input Protection Circuit



P-3



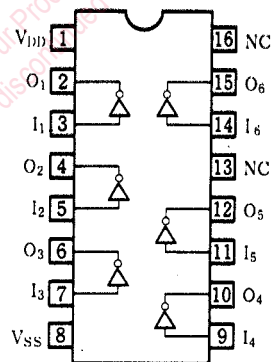
16-pin plastic DIL package

P-4



16-pin PANAFLAT package (SO-16D)

Pin Configuration



■ Absolute Maximum Ratings (Ta=25°C)

Item	Symbol	Rating	Unit
Supply voltage	V_{DD}	-0.5~+18	V
Input voltage	V_I	-0.5~ $V_{DD}+0.5^*$	V
Output pin voltage	V_O	-0.5~ $V_{DD}+0.5^*$	V
Peak input · output pin current	$\pm I_I$	max. 10	mA
Power dissipation (per package)	$T_a = -40 \sim +60^\circ\text{C}$	max. 400	mW
	$T_a = +60 \sim +80^\circ\text{C}$	Decrease to 200mW at the rate of 8mW/°C	
Power dissipation (per output pin)	P_D	max. 100	mW
Operating ambient temperature	T_{opr}	-40~+85	°C
Storage temperature	T_{stg}	-65~+150	°C

* $V_{DD}+0.5\text{V}$ should be lower than 18V.

■ Guaranteed Fan-Out for Logic Circuit Series

Driving IC	Guaranteed fan-out
Standard TTL	2
74LS	9
74L	16

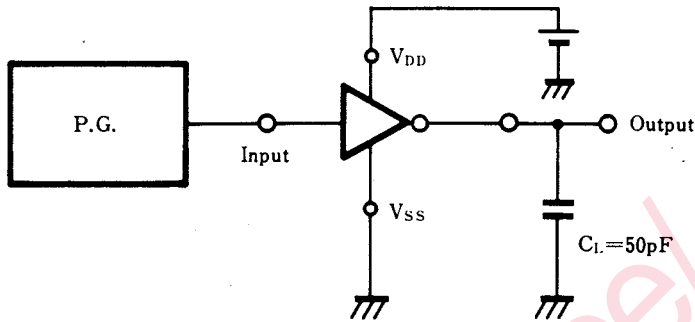
■ DC Characteristics ($V_{SS}=0V$)

Item	V_{DD} (V)	Symbol	Condition	$T_a=-40^{\circ}C$		$T_a=25^{\circ}C$		$T_a=85^{\circ}C$		Unit	
				min.	max.	min.	max.	min.	max.		
Static supply current	5	I_{DD}	$V_i=V_{SS}$ or V_{DD}	—	4	—	4	—	30	μA	
	10			—	8	—	8	—	60		
	15			—	16	—	16	—	120		
Output voltage low level	5	V_{OL}	$V_i=V_{SS}$ or V_{DD} $I_{OL}<1\mu A$	—	0.05	—	0.05	—	0.05	V	
	10			—	0.05	—	0.05	—	0.05		
	15			—	0.05	—	0.05	—	0.05		
Output voltage high level	5	V_{OH}	$V_i=V_{SS}$ or V_{DD} $I_{OL}<1\mu A$	4.95	—	4.95	—	4.95	—	V	
	10			9.95	—	9.95	—	9.95	—		
	15			14.95	—	14.95	—	14.95	—		
Input voltage low level	5	V_{IL}	$I_{OL}<1\mu A$	$V_O=0.5V$ or $4.5V$	—	1.5	—	1.5	—	V	
	10			$V_O=1V$ or $9V$	—	3	—	3	—		3
	15			$V_O=1.5V$ or $13.5V$	—	4	—	4	—		4
Input voltage high level	5	V_{IH}	$I_{OL}<1\mu A$	$V_O=0.5V$ or $4.5V$	3.5	—	3.5	—	3.5	V	
	10			$V_O=1V$ or $9V$	7	—	7	—	7		
	15			$V_O=1.5V$ or $13.5V$	11	—	11	—	11		
Output current low level	4.75	I_{OL}	$V_O=0.4V$, $V_i=0$ or $10V$	3.5	—	2.9	—	2.3	—	mA	
	10			$V_O=0.5V$, $V_i=0$ or $10V$	12	—	10	—	8		—
	15			$V_O=1.5V$, $V_i=0$ or $15V$	24	—	20	—	16		—
Output current high level	5	$-I_{OH}$	$V_O=4.6V$, $V_i=0$ or $5V$ $V_O=9.5V$, $V_i=0$ or $10V$ $V_O=13.5V$, $V_i=0$ or $15V$	0.52	—	0.44	—	0.36	—	mA	
	10			1.3	—	1.1	—	0.9	—		
	15			3.6	—	3	—	2.4	—		
Output current high level	5	$-I_{OH}$	$V_O=2.5V$, $V_i=0$ or $5V$	1.7	—	1.4	—	1.1	—	mA	
Input leakage current	15	$\pm I_i$	$V_i=0$ or $15V$	—	0.3	—	0.3	—	1	μA	

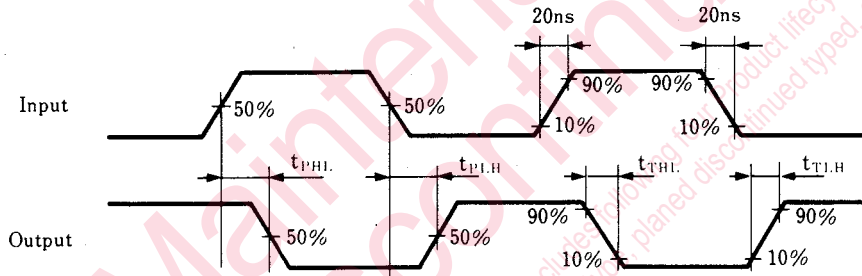
■ Switching Characteristics ($T_a=25^{\circ}C$, $V_{SS}=0V$, $C_L=50pF$)

Item	V_{DD} (V)	Symbol	min.	typ.	max.	Unit
Output rise time	5	t_{TLH}	—	60	180	ns
	10		—	30	90	
	15		—	20	60	
Output fall time	5	t_{THL}	—	25	75	ns
	10		—	10	30	
	15		—	7	21	
Propagation time	5	t_{PLH}	—	60	180	ns
	10		—	30	90	
	15		—	25	75	
Propagation time	5	t_{PHL}	—	50	150	ns
	10		—	20	60	
	15		—	15	45	
Input capacitance		C_i	—	—	7.5	pF

1. Switching time measuring circuit



2. Switching waveforms



Maintenance/Discontinued included in the product lifecycle stage.
 (planned maintenance type, maintenance type, planned discontinued type, discontinued type)



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